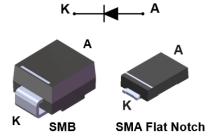


STPS2L25

Datasheet

25 V, 2 A low drop power Schottky rectifier



Features

- Very low forward voltage drop for less power dissipation
- Optimized conduction/reverse losses trade-off which means the highest efficiency in the applications
- Avalanche rated
- ECOPACK2 compliant

Applications

- Cordless appliance
- SSD
- Battery charger
- Telecom power
- DC / DC converter

Description

Schottky rectifiers designed for high frequency miniature switched mode power supplies such as adaptors and on board DC/DC converters.

Packaged in SMA Flat Notch or SMB for thermal resistance characteristic improvement, the STPS2L25 is ideal for use in parallel with MOSFETs in synchronous rectification.

Product status			
STPS2L25			
Product summary			
Symbol Value			
I _{F(AV)}	2 A		
V _{RRM}	25 V		
T _{j(max.)}	150 °C		
V _{F(typ.)} 0.325 ∨			

1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter			Value	Unit
V _{RRM}	Repetitive peak reverse voltage			25	V
I _{F(RMS)}	Forward rms current			10	Α
1	Average ferward current $\delta = 0.5$ equate wave	SMB	T _L = 125 °C	0	^
$I_{F(AV)}$ Average forward current, $\delta = 0.5$ square wave	SMA Flat Notch	T _L = 130 °C	2	A	
	Surgo non repetitive feavord surrent	SMB	t _o = 10 ms sinusoidal	75	_
I _{FSM} Surge non repetitive forward current		SMA Flat Notch		90	A
P _{ARM}	Repetitive peak avalanche power $t_p = 10 \ \mu s, T_j = 125 \ ^{\circ}C$				W
T _{stg}	Storage temperature range				°C
Tj	Maximum operating junction temperature ⁽¹⁾			+150	°C

1. $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameter

Symbol	Parameter	Max. value	Unit	
P	lunction to load	SMB	25	°C/W
R _{th(j-l)} Junction to lead		SMA Flat Notch	20	C/VV

For more information, please refer to the following application note :

AN5088 : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

Symbol	Parameter	Test	Test conditions		Тур.	Max.	Unit
L (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}	-		90	μA
'R' '		T _j = 125 °C	VR - VRRM	-	15	30	mA
		T _j = 25 °C	I _F = 2 A	-		0.450	
V (1)		T _j = 125 °C	1F - 2 A	-	0.325	0.375	
V _F ⁽¹⁾ Fc		T _j = 25 °C		-		0.530	V
		T _j = 125 °C	I _F = 4 A	-	0.430	0.510	

1. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses, use the following equation:

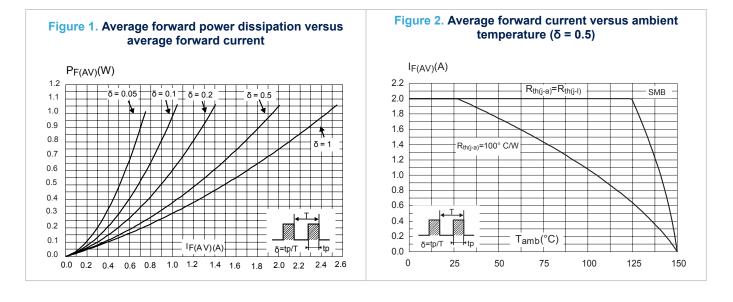
 $P = 0.24 \text{ x } I_{F(AV)} + 0.068 \text{ x } I_{F}^{2}(RMS)$

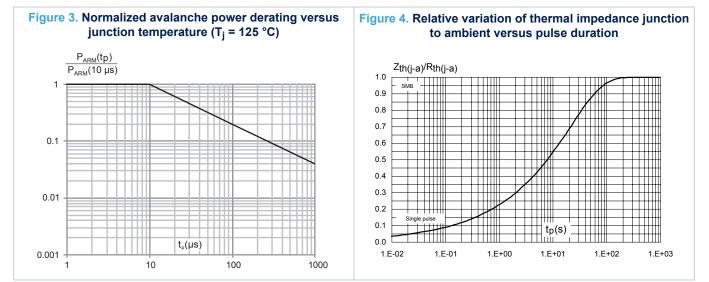
For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

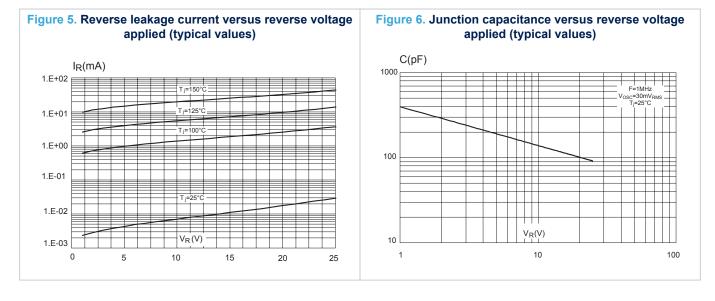


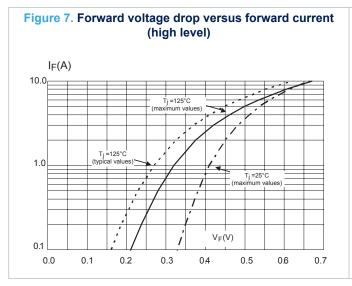
1.1 Characteristics (curves)

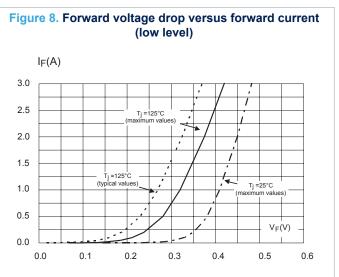












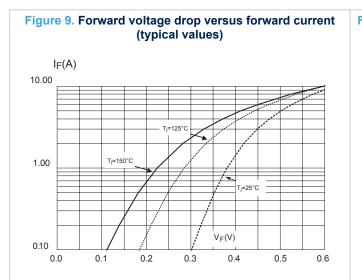
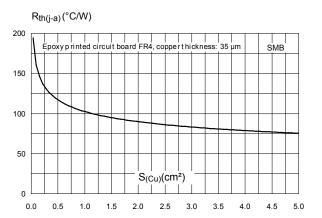


Figure 10. Thermal resistance junction to ambient versus copper surface under each lead





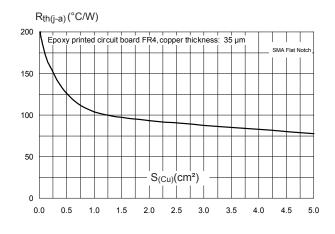


Figure 11. Thermal resistance junction to ambient versus copper surface under each lead (SMA Flat Notch)

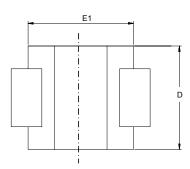
2 Package information

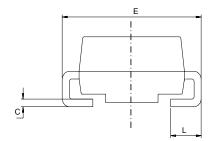
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMB package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 12. SMB package outline





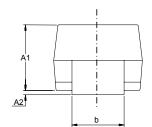
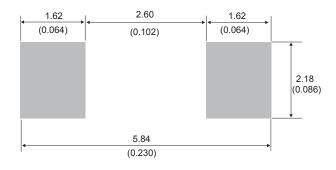


Table 4. SMB package mechanical data

	Dimensions					
Ref.	Millin	neters	Inches (for reference only)			
	Min.	Max.	Min.	Max.		
A1	1.90	2.45	0.074	0.097		
A2	0.05	0.20	0.001	0.008		
b	1.95	2.20	0.076	0.087		
С	0.15	0.40	0.005	0.016		
D	3.30	3.95	0.129	0.156		
E	5.10	5.60	0.200	0.221		
E1	4.05	4.60	0.159	0.182		
L	0.75	1.50	0.029	0.060		

Figure 13. SMB recommended footprint



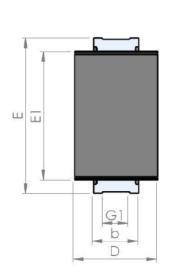
SMA Flat Notch package information 2.2

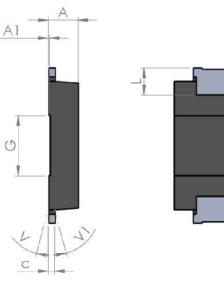
Epoxy meets UL94, V0 •

57

- Cooling method: by conduction (C)
- Band indicates cathode

Figure 14. SMA Flat Notch package outline





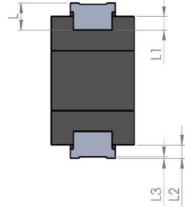
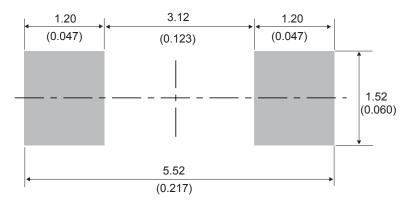


Table 5. SMA Flat Notch package mechanical data

	Dimensions					
Ref.	Millimeters			Inches (for reference only)		
	Min.	Тур.	Max.	Min.	Тур.	Max.
A1	0.90		1.10	0.035		0.044
A1		0.05			0.002	
b	1.25		1.65	0.049		0.065
С	0.15		0.40	0.005		0.016
D	2.25		2.90	0.088		0.115
Е	5.00		5.35	0.196		0.211
E1	3.95		4.60	0.155		0.182
G		2.00			0.079	
G1		0.85			0.033	
L	0.75		1.20	0.029		
L1		0.45			0.018	
L2		0.45			0.018	
L3		0.05			0.002	
V			8°			8°
V1			8°			8°





3 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS2L25U	G23	SMB	0.107 g	2500	Tape and reel
STPS2L25AFN	A22	SMA Flat Notch	0.039 g	10 000	Tape and reel

Table 6. Ordering information

Revision history

Date	Version	Changes
Jul-2003	4A	Last update.
08-Feb-2007	5	Reformatted to current standard. Added ECOPACK statement. Added SMB flat package.
09-Oct-2018	6	Updated Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified) and Figure 3. Normalized avalanche power derating versus junction temperature (T_j = 125 °C). Removed SMB flat package.
27-Sep-2019	7	Added Section 2.2 SMA Flat Notch package information.

Table 7. Document revision history



IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2019 STMicroelectronics – All rights reserved